

DATA SHEET

74LV240

Octal buffer/line driver; inverting (3-State)

Product specification
Supersedes data of 1997 Feb 19
IC24 Data Handbook

1998 May 20

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74LV240

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Typical V_{OLP} (output ground bounce) $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^{\circ}\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^{\circ}\text{C}$
- Output capability: bus driver
- I_{CC} category: MSI

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}\text{C}$; $t_r = t_f \leq 2.5\text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay 1A _n to 1Y _n ; 2A _n to 2Y _n	$C_L = 15\text{ pF}$; $V_{CC} = 3.3\text{ V}$	9.0	ns
C_I	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per buffer	$V_{CC} = 3.3\text{ V}$ $V_I = \text{GND to } V_{CC}^1$	30	pF

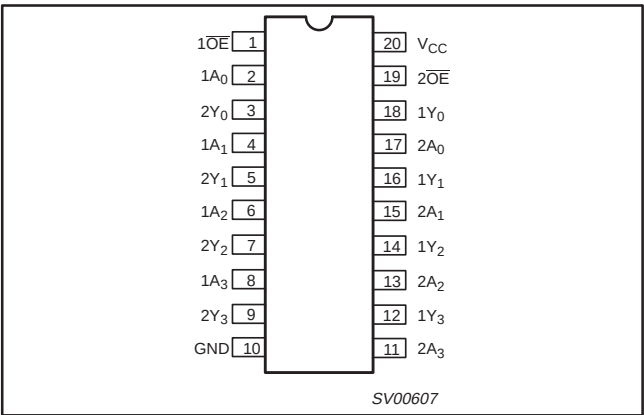
NOTE:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

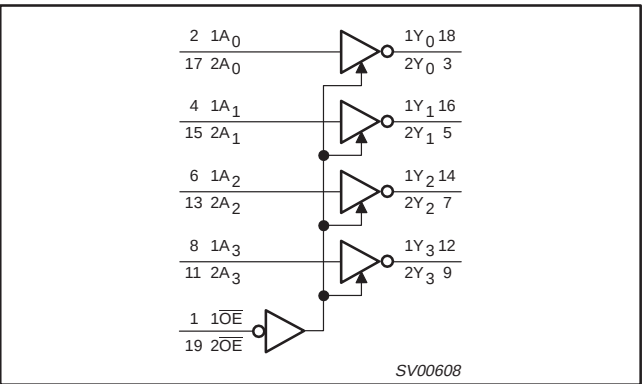
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic DIL	-40°C to $+125^{\circ}\text{C}$	74LV240 N	74LV240 N	SOT146-1
20-Pin Plastic SO	-40°C to $+125^{\circ}\text{C}$	74LV240 D	74LV240 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to $+125^{\circ}\text{C}$	74LV240 DB	74LV240 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to $+125^{\circ}\text{C}$	74LV240 PW	74LV240PW DH	SOT360-1

PIN CONFIGURATION



LOGIC SYMBOL



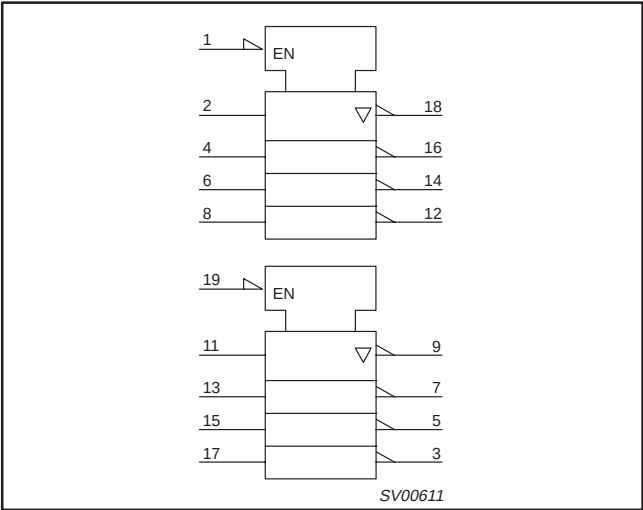
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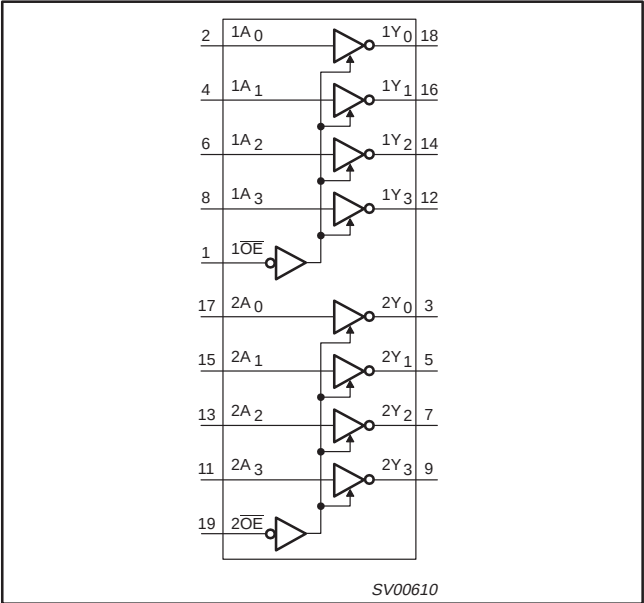
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	$1\overline{OE}$	Output enable input (active LOW)
2, 4, 6, 8	$1A_0$ to $1A_3$	Data inputs
3, 5, 7, 9	$2Y_0$ to $2Y_3$	Bus outputs
10	GND	Ground (0 V)
17, 15, 13, 11	$2A_0$ to $2A_3$	Data inputs
18, 16, 14, 12	$1Y_0$ to $1Y_3$	Bus outputs
19	$2\overline{OE}$	Output enable input (active LOW)
20	V_{CC}	Positive supply voltage

LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



FUNCTION TABLE

INPUTS		OUTPUT
$n\overline{OE}$	nA_n	nY_n
L	L	H
L	H	L
H	X	Z

NOTES:
H = HIGH voltage level
L = LOW voltage level
X = don't care
Z = high impedance OFF-state

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	–40 –40		+85 +125	°C
t_r, t_f	Input rise and fall times	$V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$ $V_{CC} = 3.6V$ to $5.5V$	– – – –	– – – –	500 200 100 50	ns/V

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		–0.5 to +7.0	V
$\pm I_{IK}$	DC input diode current	$V_I < -0.5$ or $V_I > V_{CC} + 0.5V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_O < -0.5$ or $V_O > V_{CC} + 0.5V$	50	mA
$\pm I_O$	DC output source or sink current – bus driver outputs	$-0.5V < V_O < V_{CC} + 0.5V$	35	mA
$\pm I_{GND},$ $\pm I_{CC}$	DC V_{CC} or GND current for types with – bus driver outputs		70	mA
T_{stg}	Storage temperature range		–65 to +150	°C
P_{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: –40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	
V _{IH}	HIGH level Input voltage	V _{CC} = 1.2V	0.9			0.9		V
		V _{CC} = 2.0V	1.4			1.4		
		V _{CC} = 2.7 to 3.6V	2.0			2.0		
		V _{CC} = 4.5 to 5.5V	0.7 * V _{CC}			0.7 * V _{CC}		
V _{IL}	LOW level Input voltage	V _{CC} = 1.2V			0.3		0.3	V
		V _{CC} = 2.0V			0.6		0.6	
		V _{CC} = 2.7 to 3.6V			0.8		0.8	
		V _{CC} = 4.5 to 5.5			0.3 * V _{CC}		0.3 * V _{CC}	
V _{OH}	HIGH level output voltage; all outputs	V _{CC} = 1.2V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA		1.2				V
		V _{CC} = 2.0V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	1.8	2.0		1.8		
		V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	2.5	2.7		2.5		
		V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	2.8	3.0		2.8		
		V _{CC} = 4.5V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	4.3	4.5		4.3		
V _{OH}	HIGH level output voltage; BUS driver outputs	V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; -I _O = 8mA	2.40	2.82		2.20		V
		V _{CC} = 4.5V; V _I = V _{IH} or V _{IL} ; -I _O = 16mA	3.60	4.20		3.50		
V _{OL}	LOW level output voltage; all outputs	V _{CC} = 1.2V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0				V
		V _{CC} = 2.0V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2	
		V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2	
		V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2	
		V _{CC} = 4.5V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2	
V _{OL}	LOW level output voltage; BUS driver outputs	V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 8mA		0.20	0.40		0.50	V
		V _{CC} = 4.5V; V _I = V _{IH} or V _{IL} ; I _O = 16mA		0.35	0.55		0.65	
I _I	Input leakage current	V _{CC} = 5.5V; V _I = V _{CC} or GND			1.0		1.0	µA
I _{OZ}	3-State output OFF-state current	V _{CC} = 5.5V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND			5		10	µA
I _{CC}	Quiescent supply current; MSI	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			20.0		160	µA
ΔI _{CC}	Additional quiescent supply current per input	V _{CC} = 2.7V to 3.6V; V _I = V _{CC} – 0.6V			500		850	µA

NOTE:1. All typical values are measured at $T_{amb} = 25^\circ C$.

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f \leq 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 1\text{k}\Omega$

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				−40 to +85 °C			−40 to +125 °C		
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
t _{PHL} /t _{PLH}	Propagation delay 1A _n to 1Y _n ; 2A _n to 2Y _n	Figures 1	1.2		55				ns
			2.0		19	24		31	
			2.7		14	18		23	
			3.0 to 3.6		10 ²	14		18	
			4.5 to 5.5			12		15	
t _{PZH} /t _{PZL}	3-State output enable time 1OE to 1Y _n ; 2OE to 2Y _n	Figures 2	1.2		70				ns
			2.0		24	32		41	
			2.7		18	24		30	
			3.0 to 3.6		13 ²	19		24	
			4.5 to 5.5			16		20	
t _{PHZ} /t _{PLZ}	3-State output disable time 1OE to 1Y _n ; 2OE to 2Y _n	Figures 2	1.2		65				ns
			2.0		24	29		36	
			2.7		18	22		27	
			3.0 to 3.6		14 ²	18		22	
			4.5 to 5.5			15		18	

- NOTES:
1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^\circ\text{C}$
 2. Typical values are measured at $V_{CC} = 3.3\text{ V}$.

AC WAVEFORMS

$V_M = 1.5\text{V}$ at $V_{CC} \geq 2.7\text{V}$ and $\leq 3.6\text{V}$;
 $V_M = 0.5\text{V} \times V_{CC}$ at $V_{CC} < 2.7\text{V}$ and $\geq 4.5\text{V}$.
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.
 $V_X = V_{OL} + 0.3\text{V}$ at $V_{CC} \geq 2.7\text{V}$ and $\leq 3.6\text{V}$
 $V_X = V_{OL} + 0.1\text{V} \times V_{CC}$ at $V_{CC} < 2.7\text{V}$ and $\geq 4.5\text{V}$
 $V_Y = V_{OH} - 0.3\text{V}$ at $V_{CC} \geq 2.7\text{V}$ and $\leq 3.6\text{V}$
 $V_Y = V_{OH} - 0.1 \times V_{CC}$ at $V_{CC} < 2.7\text{V}$ and $\geq 4.5\text{V}$

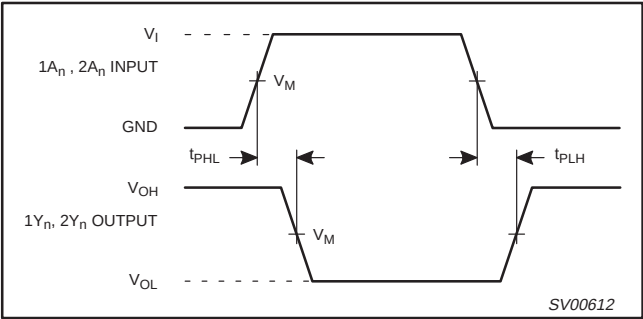


Figure 1. Input (1A_n, 2A_n) to output (1Y_n, 2Y_n) propagation delays.

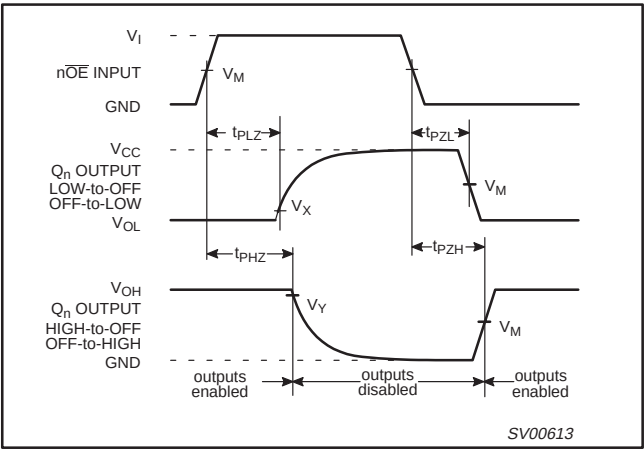


Figure 2. 3-State enable and disable times.

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TEST CIRCUIT

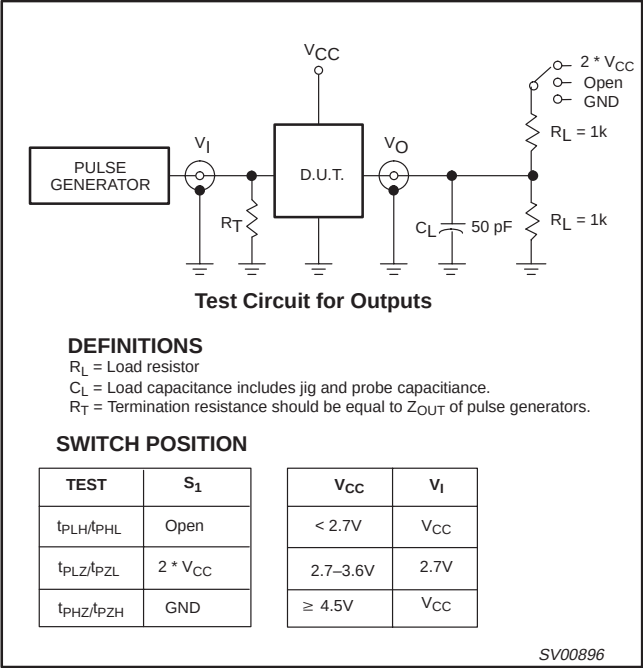


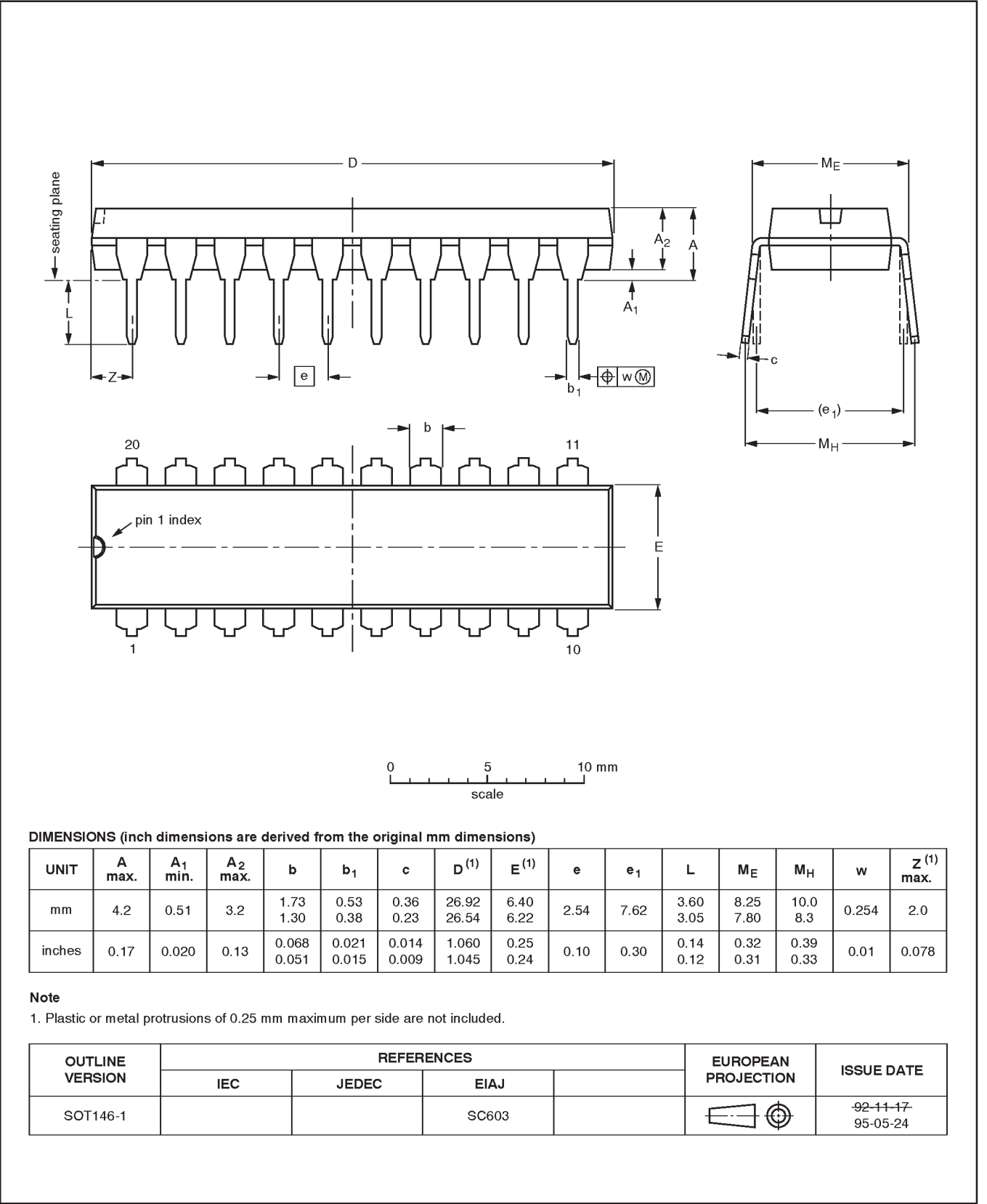
Figure 3. Load circuitry for switching times.

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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1

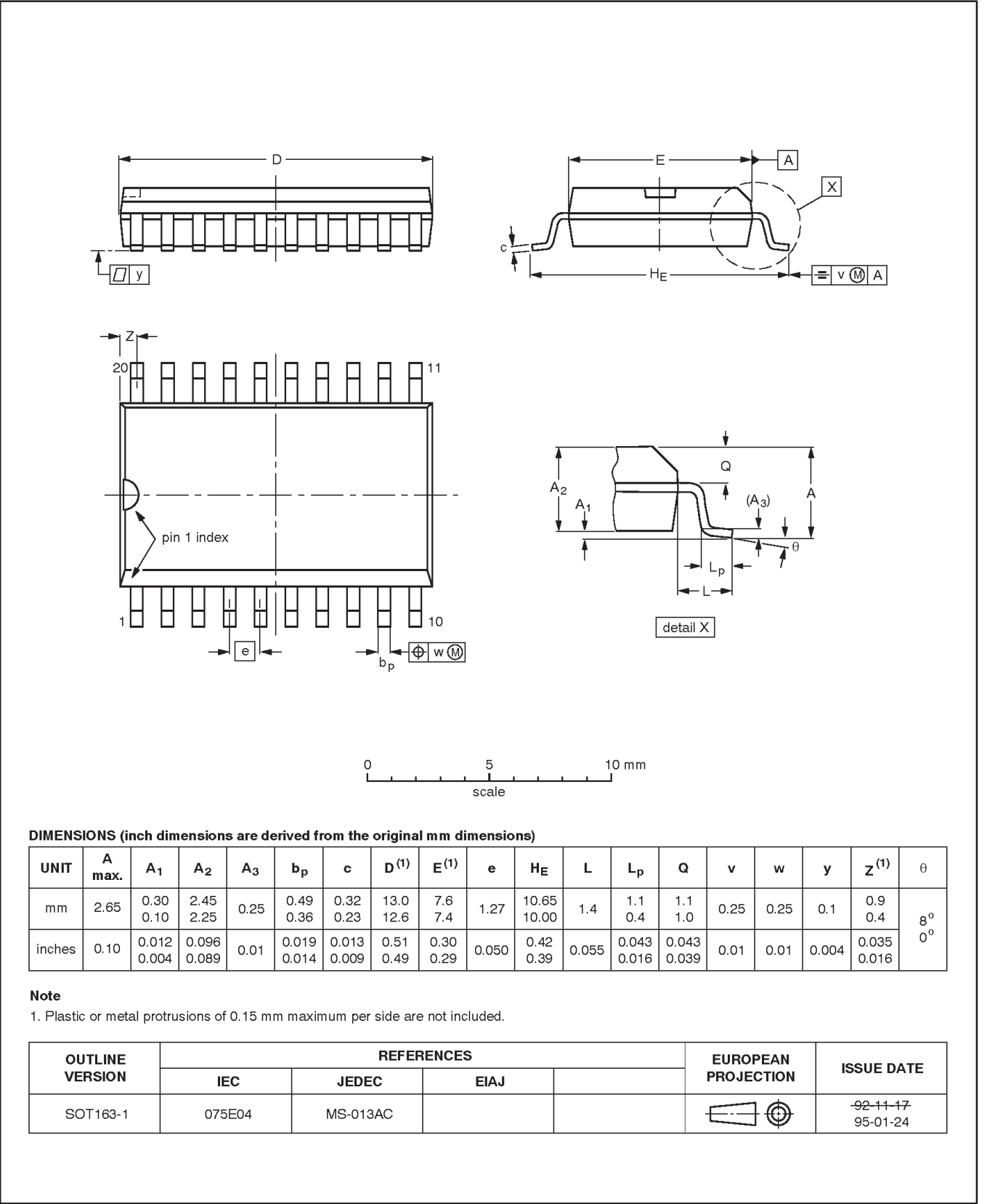


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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

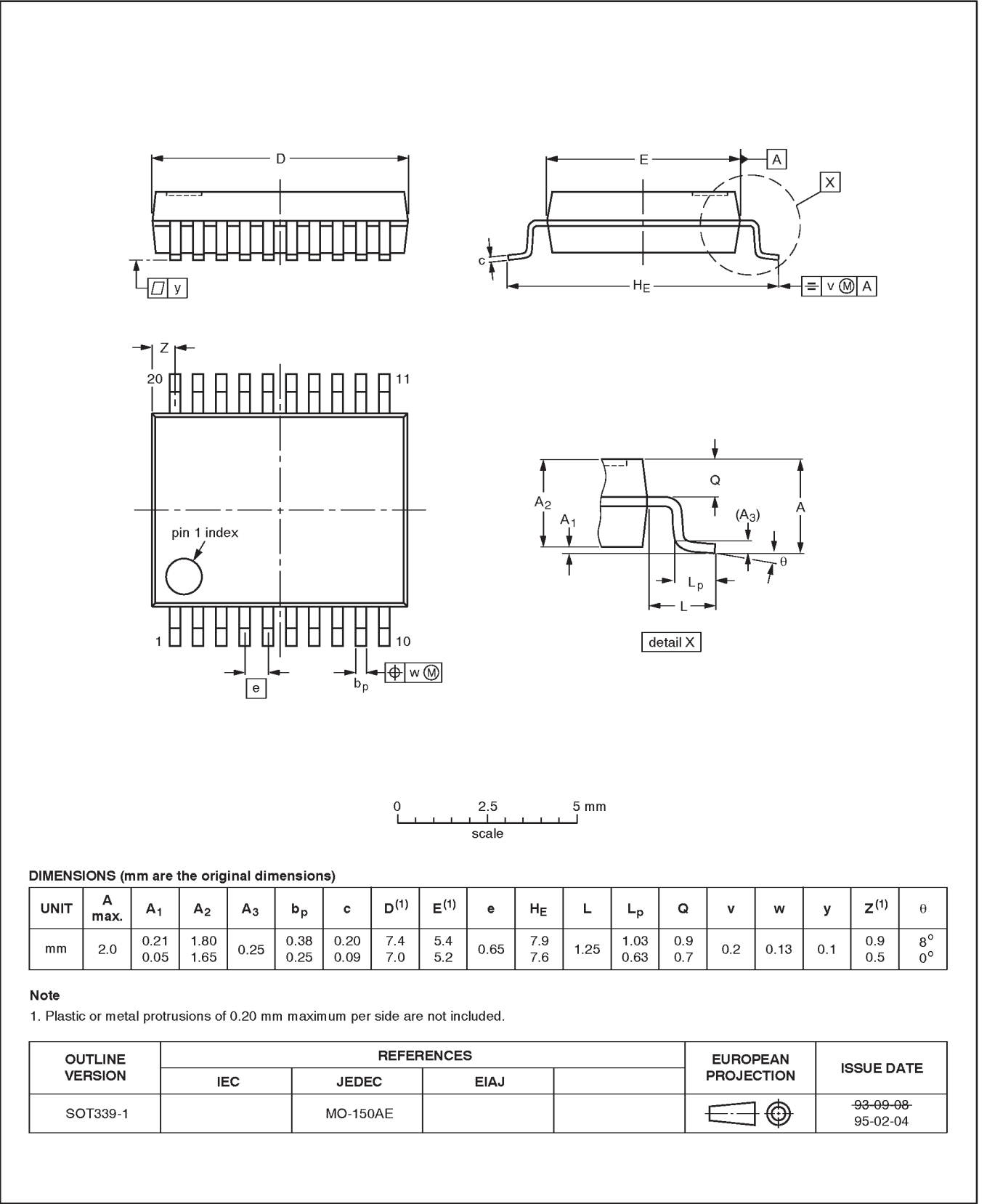


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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

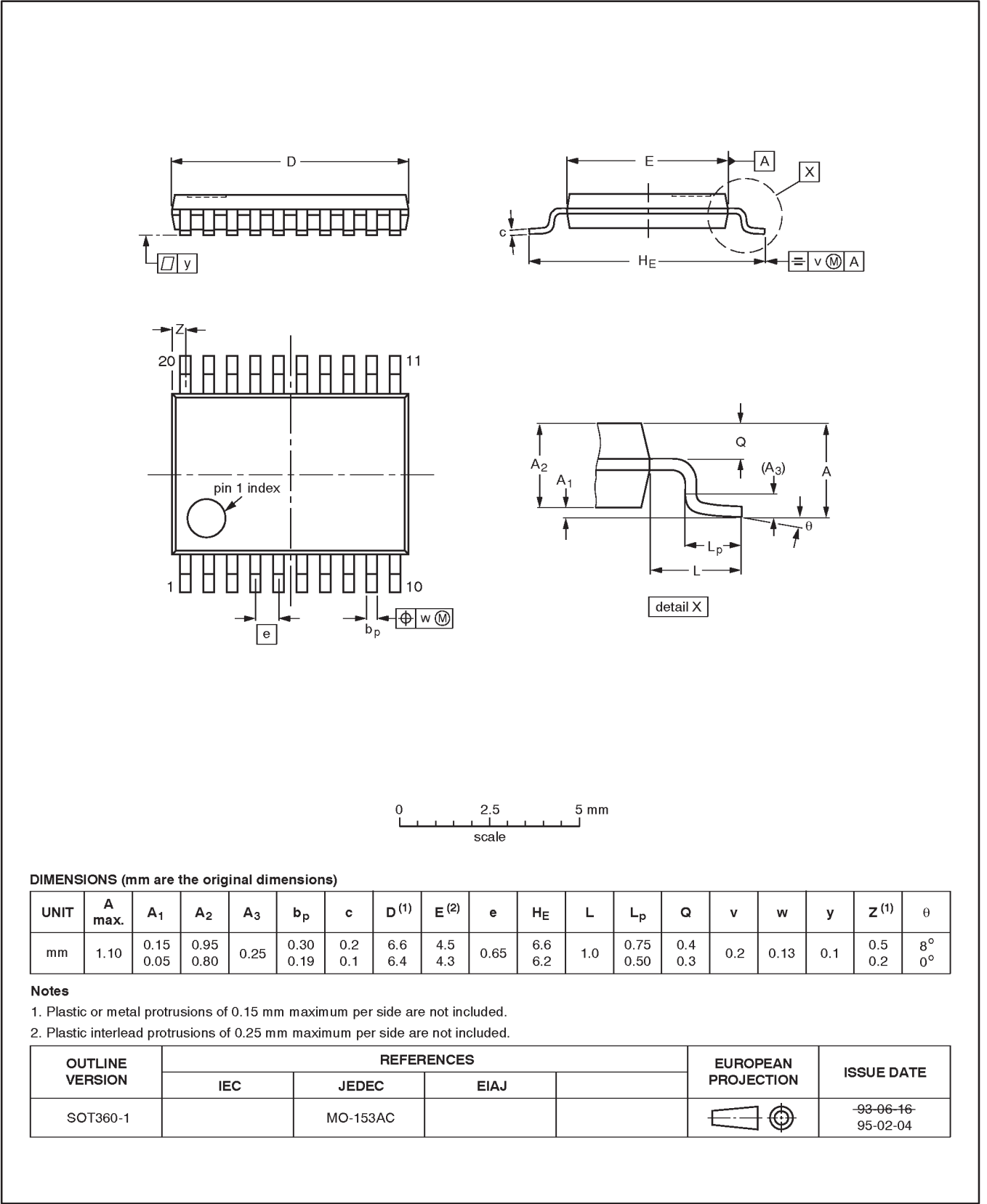


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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



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DEFINITIONS		
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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